

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>SunLED</u> XZMOK60W

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



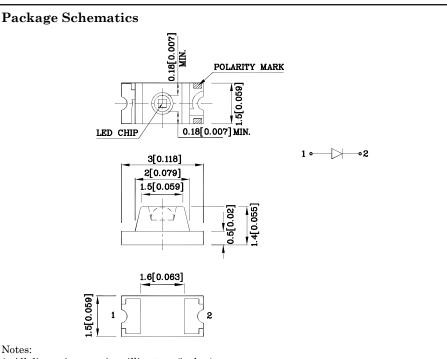
Part Number: XZMOK60W

3.0mmx1.5mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant





Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		MOK (AlGaInP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	195	mA	
Power Dissipation	\mathbf{P}_{D}	75	mW	
Operating Temperature	TA	$-40 \sim +85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$	-0	

Operating Characteristics (T _A =25°C)		MOK (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.1	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V
Reverse Current (Max.) $(V_R=5V)$	I_R	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)	λP	610*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) $(I_F=20mA)$	λD	601*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle\lambda$	29	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMOK60W	Orange	AlGaInP	Water Clear	350 120*	597 347*	610*	70°

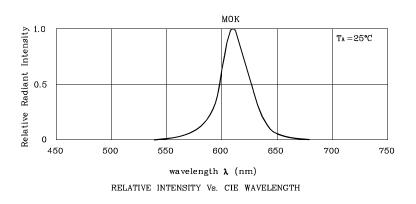
*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

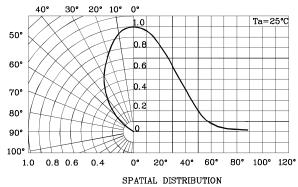
Feb 14,2014

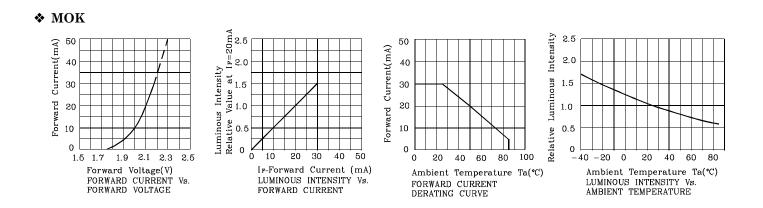


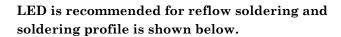
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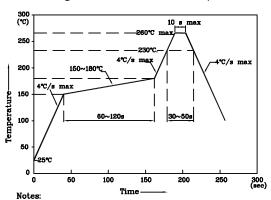








Reflow Soldering Profile for SMD Products (Pb-Free Components)

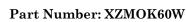


1. Maximum soldering temperature should not exceed 260°C

2. Recommended reflow temperature: 145°C-260°C

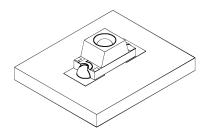
3. Do not put stress to the epoxy resin during high temperatures conditions



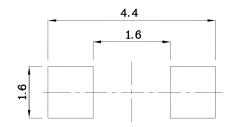


3.0mmx1.5mm SMD CHIP LED LAMP

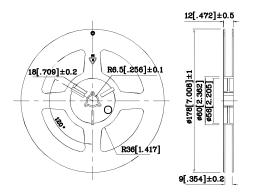
♦ The device has a single mounting surface. The device must be mounted according to the specifications.



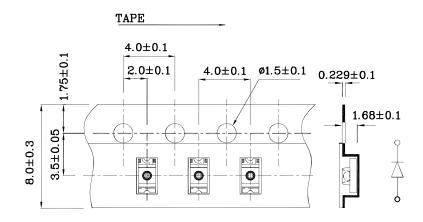
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

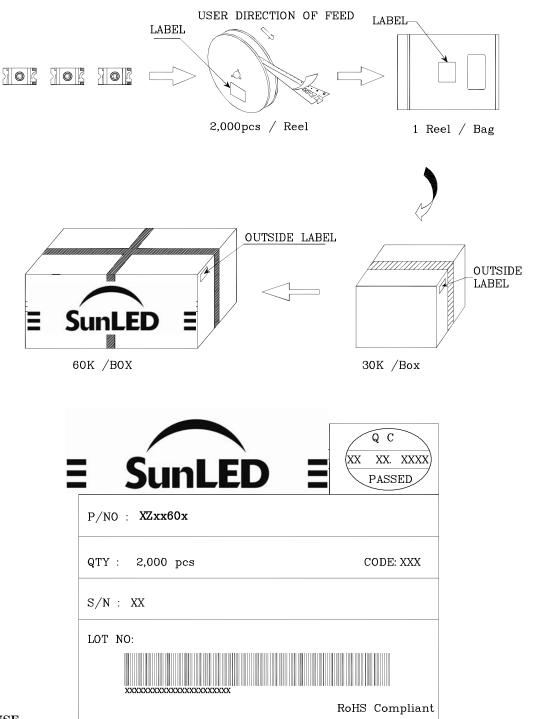
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PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$

Feb 14,2014

XDSA1404 V8-X Layout: Maggie L.